捷多邦,专业PCB打样工厂,24小时加急出货LM2902-Q1 QUADRUPLE OPERATIONAL AMPLIFIER

SGLS178D - AUGUST 2003 - REVISED DECEMBER 2004

- Qualification in Accordance With AEC-Q100†
- **Qualified for Automotive Applications**
- **Customer-Specific Configuration Control** Can Be Supported Along With Major-Change Approval
- ESD Protection <500 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0); 1500 V Using Charged Device Model
- ESD Human Body Model >2 kV Machine Model >200 V and Charge Device Model = 2 kV For K-Suffix Devices.
- Low Supply-Current Drain Independent of Supply Voltage . . . 0.8 mA Typ
- **Low Input Bias and Offset Parameters:**
 - Input Offset Voltage . . . 3 mV Typ
 - Input Offset Current . . . 2 nA Typ
 - Input Bias Current . . . 20 nA Typ
- † Contact factory for details. Q100 qualification data available on

- **Common-Mode Input Voltage Range** Includes Ground, Allowing Direct Sensing **Near Ground**
- Differential Input Voltage Range Equal to Maximum-Rated Supply Voltage:
 - Non-V devices . . . 26 V
 - V-Suffix devices . . . 32 V
- **Open-Loop Differential Voltage** Amplification . . . 100 V/mV Typ
- **Internal Frequency Compensation**

D OR PW PACKAGE (TOP VIEW)

10UT [1	U] 40UT
1IN- [2] 4IN-
1IN+ [3		12] 4IN+
V _{CC}	4		11] GND
2IN+ [5		10] 3IN+
2IN- [6		9] 3IN-
20UT [7		8] 30UT
	_			l

description/ordering information

This device consists of four independent high-gain frequency-compensated operational amplifiers that are designed specifically to operate from a single supply over a wide range of voltages. Operation from split supplies is possible when the difference between the two supplies is 3 V to 26 V (3 V to 32 V for V-suffixed devices), and V_{CC} is at least 1.5 V more positive than the input common-mode voltage. The low supply-current drain is independent of the magnitude of the supply voltage.

Applications include transducer amplifiers, dc amplification blocks, and all the conventional operational-amplifier circuits that now can be more easily implemented in single-supply-voltage systems. For example, the LM2902 can be operated directly from the standard 5-V supply that is used in digital systems and easily provides the required interface electronics without requiring additional ±15-V supplies.

ORDERING INFORMATION

TA	V _{IO} max AT 25°C	MAX V _{CC}	PACKAGE‡		ORDERABLE PART NUMBER	TOP-SIDE MARKING
	7 mV	26 V	SOIC (D)	Reel of 2500	LM2902QDRQ1	2902Q1
–40°C to 125°C			TSSOP (PW)	Reel of 2000	LM2902QPWRQ1	2902Q1
	7 mV	32 V	SOIC (D)	Reel of 2500	LM2902KVQDRQ1	2902KVQ
			TSSOP (PW)	Reel of 2000	LM2902KVQPWRQ1	2902KVQ
		32 V	SOIC (D)	Reel of 2500	LM2902KAVQDRQ1	2902KAQ
			TSSOP (PW)	Reel of 2000	LM2902KAVQPWRQ1	2902KAQ

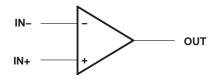
Package drawings, standard packing quantities, thermal data, symbolization, and PCB design quidelines are available at www.ti.com/sc/package.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of

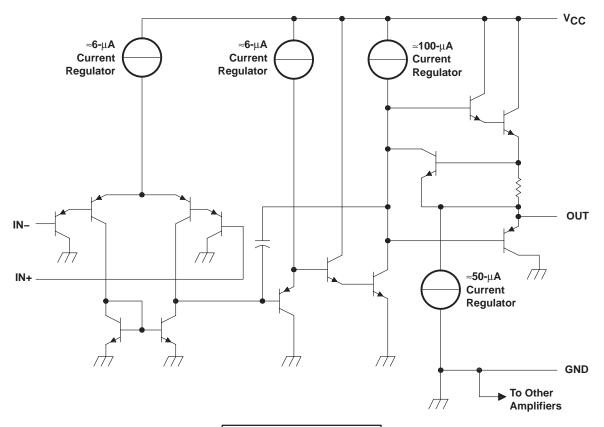


SGLS178D - AUGUST 2003 - REVISED DECEMBER 2004

symbol (each amplifier)



schematic (each amplifier)



COMPONENT COUNT (TOTAL DEVICE)						
Epi-FET	1					
Transistors	95					
Diodes	4					
Resistors	11					
Capacitors	4					



SGLS178D - AUGUST 2003 - REVISED DECEMBER 2004

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

		LM2902-Q1	LM2902KV-Q1	UNIT	
Supply voltage, V _{CC} (see Note 1)	26	32	V		
Differential input voltage, V _{ID} (see Note 2)	±26	±32	V		
Input voltage, V _I (either input)	-0.3 to 26	-0.3 to 32	V		
Duration of output short circuit (one amplifier) to ground at (or belonote 3)	Unlimited	Unlimited			
5 1 1 1 1 0 (N 1 1 5)	D package (0 LFPM)	101	101	0000	
Package thermal impedance, θ _{JA} (see Notes 4 and 5) PW package		113	113	°C/W	
Operating virtual junction temperature, T _J	142	142	°C		
Storage temperature range, T _{Stg}	-65 to 150	-65 to 150	°C		

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values, except differential voltages and VCC specified for the measurement of IOS, are with respect to the network GND.
 - 2. Differential voltages are at IN+ with respect to IN-.
 - 3. Short circuits from outputs to V_{CC} can cause excessive heating and eventual destruction.
 - Maximum power dissipation is a function of T_J(max), θ_JA, and T_A. The maximum allowable power dissipation at any allowable ambient temperature is P_D = (T_J(max) T_A)/θ_JA. Operating at the absolute maximum T_J of 142°C can affect reliability.
 - 5. The package thermal impedance is calculated in accordance with JESD 51-7.



SGLS178D - AUGUST 2003 - REVISED DECEMBER 2004

electrical characteristics at specified free-air temperature, $V_{CC} = 5 \text{ V}$ (unless otherwise noted)

PARAMETER		TEST CONDITIONS [†]		t	LM2	902-Q1		LINUT	
		TEST COI	NDITIONS	T _A ‡	MIN	TYP§	MAX	UNIT	
\/	Input offect voltage	$V_{CC} = 5 \text{ V to } 2$	26 V,	25°C		3	7	mV	
VIO	Input offset voltage			Full range			10	mv	
li o	Input offset current	V 44V		25°C		2	50	^	
lio	input offset current	V _O = 1.4 V		Full range			300	nA	
lun.	Input bias current	VO = 1.4 V		25°C		-20	-250	nA	
ΙΒ	input bias current	VO = 1.4 V		Full range			-500	IIA	
V _{ICR}	Common-mode input voltage range	V _{CC} = 5 V to 2	26 V	25°C	0 to V _{CC} - 1.5			V	
VICR	Common-mode input voitage range	VCC = 3 V 10 2	20 V	Full range	0 to V _{CC} - 2			٧	
		$R_L = 10 \text{ k}\Omega$		25°C	V _{CC} - 1.5				
VOH	High-level output voltage	$V_{CC} = 26 \text{ V},$	$R_L = 2 k\Omega$	Full range	22			V	
		$V_{CC} = 26 \text{ V},$	$R_L \ge 10 \ k\Omega$	Full range	23	24			
V_{OL}	Low-level output voltage	$R_L \le 10 \text{ k}\Omega$		Full range		5	20	mV	
۸	Large-signal differential voltage	V_{CC} = 15 V, V_{O} = 1 V to 11 V, $R_L \ge 2 k\Omega$		25°C		100		V/mV	
AVD	amplification			Full range	15				
CMRR	Common-mode rejection ratio	V _{IC} = V _{ICR} mi	n	25°C	50	80		dB	
ksvr	Supply-voltage rejection ratio ($\Delta V_{CC}/\Delta V_{IO}$)			25°C	50	100		dB	
V _{O1} /V _{O2}	Crosstalk attenuation	f = 1 kHz to 20) kHz	25°C		120		dB	
		V _{CC} = 15 V,	$V_{ID} = 1 V$	25°C	-20	-30	-60		
		V _O = 0		Full range	-10			mA	
IO	Output current	$V_{CC} = 15 V$,	$V_{ID} = -1 V$,	25°C	10	20		IIIA	
		V _O = 15 V		Full range	5				
		$V_{ID} = -1 V$,	$V_O = 200 \text{ mV}$	25°C		30		μΑ	
los	Short-circuit output current	V _{CC} at 5 V, GND at -5 V	$V_{O} = 0$,	25°C		±40	±60	mA	
	Complete	$V_0 = 2.5 V$,	No load	Full range		0.7	1.2		
ICC	Supply current (four amplifiers)	V _{CC} = 26 V V _O = 0.5 V _{CC}	, No load	Full range		1.4	3	mA	

[†] All characteristics are measured under open-loop conditions, with zero common-mode input voltage, unless otherwise specified.



[‡] Full range is -40° C to 125°C. § All typical values are at T_A = 25°C.

SGLS178D - AUGUST 2003 - REVISED DECEMBER 2004

electrical characteristics at specified free-air temperature, V_{CC} = 5 V (unless otherwise noted) (continued)

DADAMETED		TEOT 001	DITIONS	T. T	LM29	02KV-Q1		UNIT	
	PARAMETER	TEST CON	DITIONS	T _A ‡	MIN	TYP§	MAX	UNIT	
		Va = 5 V to 22	Non-A	25°C		3	7		
\/	Input offset voltage	V _{CC} = 5 V to 32 V,	devices	Full range			10		
VIO	input onset voltage	V _{IC} = V _{ICR} min, V _O = 1.4 V	A-suffix	25°C		1	2	mV	
		VO = 1.4 V	devices	Full range			4		
ΔV _{IO} /ΔΤ	Temperature drift	$R_S = 0 \Omega$		Full range		7		μV/°C	
l.o	Input offset current	V _O = 1.4 V		25°C		2	50	nA	
lio	input onset current	VO = 1.4 V		Full range			150	ПА	
ΔΙ _{ΙΟ} /ΔΤ	Temperature drift			Full range		10		pA/°C	
I _{IB}	Input bias current	V _O = 1.4 V		25°C		-20	-250	nA	
ııB	input bias current	VO = 1.4 V		Full range			-500	ш	
Vion	Common-mode input voltage range	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	,	25°C	0 to V _{CC} - 1.5			V	
VICR	Common-mode input voltage range	VCC = 3 V to 32 V	V _{CC} = 5 V to 32 V					V	
	High-level output voltage	R _L = 10 kΩ	25°C	V _{CC} - 1.5			V		
Vон		V _{CC} = 32 V,	Full range	26					
		V _{CC} = 32 V,	$R_L \ge 10 \text{ k}\Omega$	Full range	27				
VOL	Low-level output voltage	R _L ≤ 10 kΩ		Full range		5	20	mV	
Δ	Large-signal differential voltage	V _{CC} = 15 V, V _O = 1 V to 11 V,		25°C	25	100		V/mV	
AVD	amplification	R _L ≥ 2 kΩ	Full range	15					
	Amplifier-to-amplifier coupling¶	f = 1 kHz to 20 kHz input referred	Z,	25°C		120		dB	
CMRR	Common-mode rejection ratio	$V_{IC} = V_{ICR}min$		25°C	60	80		dB	
ksvr	Supply-voltage rejection ratio (ΔV _{CC} /ΔV _{IO})			25°C	60	100		dB	
V _{O1} /V _{O2}	Crosstalk attenuation	f = 1 kHz to 20 kH:	Z	25°C		120		dB	
		V _{CC} = 15	V 4V	25°C	-20	-30	-60		
		VO = 0	$V_{ID} = 1 V$,	Full range	-10			4	
IO	Output current	V _{CC} = 15	V 4V	25°C	10	20		mA	
		V _O = 15 V	$V_{ID} = -1 V$,	Full range	5				
		$V_{ID} = -1 V$,	$V_O = 200 \text{ mV}$	25°C	12	40		μΑ	
los	Short-circuit output current	V _{CC} at 5 V, GND at –5 V	$V_{O} = 0,$	25°C		±40	±60	mA	
		V _O = 2.5 V,	No load	Full range		0.7	1.2		
ICC	Supply current (four amplifiers)	V _{CC} = 32 V V _O = 0.5 V _{CC} ,	No load	Full range		1.4	3	mA	

[†] All characteristics are measured under open-loop conditions, with zero common-mode input voltage, unless otherwise specified.



[‡] Full range is -40°C to 125°C.

[§] All typical values are at $T_A = 25$ °C.

[¶] Due to proximity of external components, ensure that coupling is not originating via stray capacitance between these external parts. Typically, this can be detected, as this type of coupling increases at higher frequencies.

SGLS178D - AUGUST 2003 - REVISED DECEMBER 2004

operating conditions, V_{CC} = ± 15 V, T_A = $25^{\circ}C$

	PARAMETER	TEST CONDITIONS	TYP	UNIT
SR	Slew rate at unity gain	$R_L = 1 \text{ M}\Omega$, $C_L = 30 \text{ pF}$, $V_I = \pm 10 \text{ V}$ (see Figure 1)	0.5	V/µs
B ₁	Unity-gain bandwidth	$R_L = 1 M\Omega$, $C_L = 20 pF$ (see Figure 1)	1.2	MHz
Vn	Equivalent input noise voltage	$R_S = 100 \Omega$, $V_I = 0 V$, $f = 1 kHz$ (see Figure 2)	35	nV/√ Hz

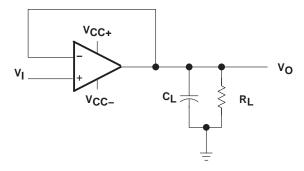


Figure 1. Unity-Gain Amplifier

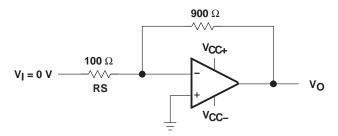


Figure 2. Noise-Test Circuit



PACKAGE OPTION ADDENDUM

29-May-2007

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
LM2902KAVQDRQ1	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
LM2902KAVQPWRQ1	ACTIVE	TSSOP	PW	14	2000	TBD	CU NIPDAU	Level-1-250C-UNLIM
LM2902KVQDRQ1	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
LM2902KVQPWRQ1	ACTIVE	TSSOP	PW	14	2000	TBD	CU NIPDAU	Level-1-250C-UNLIM
LM2902QDRQ1	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
LM2902QPWRQ1	ACTIVE	TSSOP	PW	14	2000	TBD	CU NIPDAU	Level-1-250C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

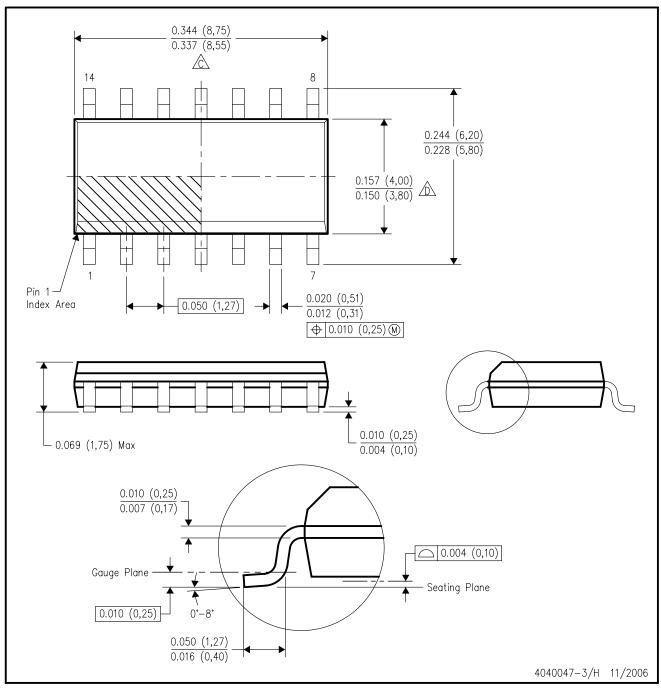
(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AB.



PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153

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